

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China







Data sheet

BMP180Digital pressure sensor

Bosch Sensortec



BMP180 Data sheet

Document revision 2.4

Document release date 27 January 2012

Document number BST-BMP180-DS000-08

Technical reference code(s) 0 273 300 244

Notes Data in this document are subject to change without notice. Product

photos and pictures are for illustration purposes only and may differ from

the real product's appearance.



Page 2

BMP180

DIGITAL PRESSURE SENSOR

Key features

Pressure range: 300 ... 1100hPa (+9000m ... -500m relating to sea level)

Supply voltage: 1.8 ... 3.6V (V_{DD})

1.62V ... 3.6V (V_{DDIO})

Package: LGA package with metal lid

Small footprint: 3.6mm x 3.8mm Super-flat: 0.93mm height

Low power: $5\mu A$ at 1 sample / sec. in standard mode

Low noise: 0.06hPa (0.5m) in ultra low power mode

0.02hPa (0.17m) ultra high resolution mode

- Temperature measurement included

- I²C interface

- Fully calibrated

- Pb-free, halogen-free and RoHS compliant,

- MSL 1

Typical applications

- Enhancement of GPS navigation (dead-reckoning, slope detection, etc.)
- In- and out-door navigation
- Leisure and sports
- Weather forecast
- Vertical velocity indication (rise/sink speed)



Page 3

BMP180 general description

The BMP180 is the function compatible successor of the BMP085, a new generation of high precision digital pressure sensors for consumer applications.

The ultra-low power, low voltage electronics of the BMP180 is optimized for use in mobile phones, PDAs, GPS navigation devices and outdoor equipment. With a low altitude noise of merely 0.25m at fast conversion time, the BMP180 offers superior performance. The I²C interface allows for easy system integration with a microcontroller.

The BMP180 is based on piezo-resistive technology for EMC robustness, high accuracy and linearity as well as long term stability.

Robert Bosch is the world market leader for pressure sensors in automotive applications. Based on the experience of over 400 million pressure sensors in the field, the BMP180 continues a new generation of micro-machined pressure sensors.



Index of Contents

1. ELECTRICAL CHARACTERISTICS	6
2. ABSOLUTE MAXIMUM RATINGS	8
3. OPERATION	9
3.1 GENERAL DESCRIPTION	c
3.2 GENERAL FUNCTION AND APPLICATION SCHEMATICS	g
3.3 MEASUREMENT OF PRESSURE AND TEMPERATURE	11
3.3.1 Hardware pressure sampling accuracy modes	
3.5 CALCULATING PRESSURE AND TEMPERATURE	14
3.6 CALCULATING ABSOLUTE ALTITUDE	15
3.7 CALCULATING PRESSURE AT SEA LEVEL	17
4. GLOBAL MEMORY MAP	18
5. I ² C INTERFACE	19
5.1 I ² C SPECIFICATION	19
5.2 DEVICE AND REGISTER ADDRESS	20
5.3 I ² C PROTOCOL	20
5.4 START TEMPERATURE AND PRESSURE MEASUREMENT	21
5.5 READ A/D CONVERSION RESULT OR E ² PROM DATA	22
6. PACKAGE	23
6.1 PIN CONFIGURATION	23
6.2 OUTLINE DIMENSIONS	24
6.2.1 Bottom view	24
6.2.2 Top view	
6.2.3 Side view	
6.4 Rohs compliancy	
6.5 MOUNTING AND ASSEMBLY RECOMMENDATIONS	
7 LEGAL DISCLAIMED	27
/ EI_AI 115(*) AIMED	· · · · · · · · · · · · · · · · · · ·



Page 5

8	DOCUMENT HISTORY AND MODIFICATION	28
	7.3 APPLICATION EXAMPLES AND HINTS	27
	7.2 PRODUCT USE	27
	7.1 Engineering samples	27



1. Electrical characteristics

If not stated otherwise, the given values are ±3-Sigma values over temperature/voltage range in the given operation mode. All values represent the new parts specification; additional solder drift is shown separately.

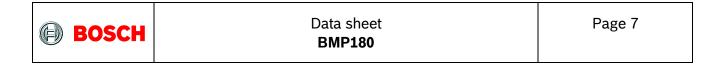
Table 1: Operating conditions, output signal and mechanical characteristics

Parameter	Symbol	Condition	Min	Тур	Max	Units
	т	operational	-40		+85	°C
Operating temperature	T_A	full accuracy	0		+65	30
0 1 1	V_{DD}	ripple max. 50mVpp	1.8	2.5	3.6	V
Supply voltage	V_{DDIO}		1.62	2.5	3.6	V
	I_{DDLOW}	ultra low power mode		3		μΑ
Supply current	I _{DDSTD}	standard mode		5		μΑ
@ 1 sample / sec.	I_{DDHR}	high resolution mode		7		μΑ
25°C	I _{DDUHR}	Ultra high res. mode		12		μΑ
	I _{DDAR}	Advanced res. mode		32		μΑ
Peak current	I _{peak}	during conversion		650	1000	μΑ
Standby current	I _{DDSBM}	@ 25°C		0.1		μΑ
		950 1050 hPa		±0.12		hPa
Relative accuracy pressure		@ 25 °C		±1.0		m
V _{DD} = 3.3V		700 900hPa 25 40 °C		±0.12		hPa
				±1.0		m
Absolute accuracy pressure		300 1100 hPa 0 +65 °C	-4.0	-1.0*	+2.0	hPa
V _{DD} = 3.3V		300 1100 hPa -20 0 °C	-6.0	-1.0*	+4.5	hPa
Resolution of		pressure		0.01		hPa
output data		temperature		0.1		°C
Noise in pressure		see	age 12-13			
Absolute accuracy		@ 25 °C	-1.5	±0.5	+1.5	°C
temperature $V_{DD} = 3.3V$		0 +65 °C	-2.0	±1.0	+2.0	°C
Conversion time	$t_{\text{c_p_low}}$	ultra low power mode		3	4.5	ms

BST-BMP180-DS000-08 | Revision 2.4 | January 2012

[©] Bosch Sensortec GmbH reserves all rights even in the event of industrial property rights. We reserve all rights of disposal such as copying and passing on to third parties. BOSCH and the symbol are registered trademarks of Robert Bosch GmbH, Germany.

Note: Specifications within this document are subject to change without notice.



pressure	$t_{c_p_std}$	standard mode		5	7.5	ms
	t_{c_phr}	high resolution mode		9	13.5	ms
	t _{c_p_luhr}	ultra high res. mode		17	25.5	ms
	$t_{c_p_ar}$	Advanced res. mode		51	76.5	ms
Conversion time temperature	t_{C_temp}	standard mode		3	4.5	ms
Serial data clock	f_{SCL}				3.4	MHz
Solder drifts		Minimum solder height 50µm	-0.5		+2	hPa
Long term stability**		12 months		±1.0		hPa



2. Absolute maximum ratings

BOSCH

Table 2: Absolute maximum ratings

Parameter	Condition	Min	Max	Units
Storage temperature		-40	+85	°C
Supply voltage	all pins	-0.3	+4.25	V
ESD rating	HBM, R = 1.5kΩ, C = 100pF		±2	kV
Overpressure			10,000	hPa

The BMP180 has to be handled as Electrostatic Sensitive Device (ESD).



Figure 1: ESD



3. Operation

3.1 General description

The BMP180 is designed to be connected directly to a microcontroller of a mobile device via the I^2C bus. The pressure and temperature data has to be compensated by the calibration data of the E^2PROM of the BMP180.

3.2 General function and application schematics

The BMP180 consists of a piezo-resistive sensor, an analog to digital converter and a control unit with E^2PROM and a serial I^2C interface. The BMP180 delivers the uncompensated value of pressure and temperature. The E^2PROM has stored 176 bit of individual calibration data. This is used to compensate offset, temperature dependence and other parameters of the sensor.

- UP = pressure data (16 to 19 bit)
- UT = temperature data (16 bit)

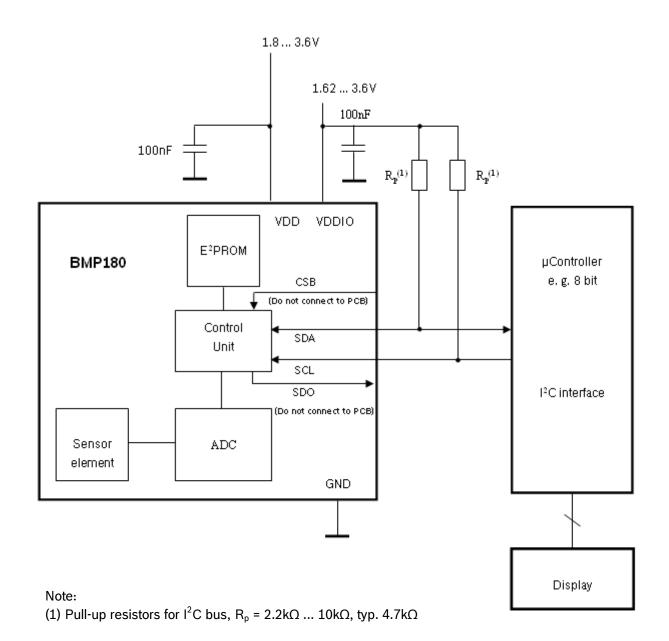


Figure 2: Typical application circuit



3.3 Measurement of pressure and temperature

For all calculations presented here an ANSI C code is available from Bosch Sensortec ("BMP180 API").

The microcontroller sends a start sequence to start a pressure or temperature measurement. After converting time, the result value (UP or UT, respectively) can be read via the I²C interface. For calculating temperature in °C and pressure in hPa, the calibration data has to be used. These constants can be read out from the BMP180 E²PROM via the I²C interface at software initialization.

The sampling rate can be increased up to 128 samples per second (standard mode) for dynamic measurement. In this case, it is sufficient to measure the temperature only once per second and to use this value for all pressure measurements during the same period.

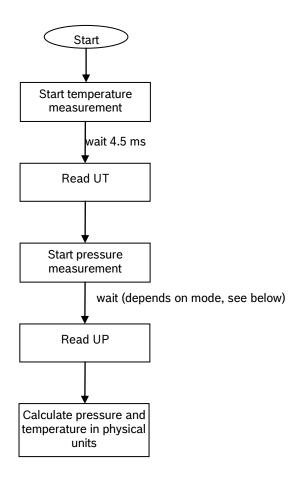


Figure 3: Measurement flow BMP180





3.3.1 Hardware pressure sampling accuracy modes

By using different modes the optimum compromise between power consumption, speed and resolution can be selected, see below table.

Table 3: Overview of BMP180 hardware accuracy modes, selected by driver software via the variable oversampling_setting

Mode	Parameter oversampling_setting	Internal number of samples	Conversion time pressure max. [ms]	Avg. current @ 1 sample/s typ. [µA]	RMS noise typ. [hPa]	RMS noise typ. [m]
ultra low power	0	1	4.5	3	0.06	0.5
standard	1	2	7.5	5	0.05	0.4
high resolution	2	4	13.5	7	0.04	0.3
ultra high resolution	3	8	25.5	12	0.03	0.25

For further information on noise characteristics see the relevant application note "Noise in pressure sensor applications".

All modes can be performed at higher speeds, e.g. up to 128 times per second for standard mode, with the current consumption increasing proportionally to the sample rate.





3.3.2 Software pressure sampling accuracy modes

For applications where a low noise level is critical, averaging is recommended if the lower bandwidth is acceptable. Oversampling can be enabled using the software API driver (with OSR = 3).

Table 4: Overview of BMP180 software accuracy mode, selected by driver software via the variable software_oversampling_setting

Mode	Parameter oversampling_setting	software_ oversampl ing_settin g	Conversion time pressure max. [ms]	Avg. current @ 1 sample/s typ. [μΑ]	RMS noise typ. [hPa]	RMS noise typ. [m]
Advanced resolution	3	1	76.5	32	0.02	0.17

3.4 Calibration coefficients

The 176 bit E^2PROM is partitioned in 11 words of 16 bit each. These contain 11 calibration coefficients. Every sensor module has individual coefficients. Before the first calculation of temperature and pressure, the master reads out the E^2PROM data.

The data communication can be checked by checking that none of the words has the value 0 or 0xFFFF.

Table 5: Calibration coefficients

	BMP180 reg adr					
Parameter	MSB	LSB				
AC1	0xAA	0xAB				
AC2	0xAC	0xAD				
AC3	0xAE	0xAF				
AC4	0xB0	0xB1				
AC5	0xB2	0xB3				
AC6	0xB4	0xB5				
B1	0xB6	0xB7				
B2	0xB8	0xB9				
MB	0xBA	0xBB				
MC	0xBC	0xBD				
MD	0xBE	0xBF				

BST-BMP180-DS000-08 | Revision 2.4 | January 2012

[©] Bosch Sensortec GmbH reserves all rights even in the event of industrial property rights. We reserve all rights of disposal such as copying and passing on to third parties. BOSCH and the symbol are registered trademarks of Robert Bosch GmbH, Germany.

Note: Specifications within this document are subject to change without notice.



Page 14

3.5 Calculating pressure and temperature

The mode (ultra low power, standard, high, ultra high resolution) can be selected by the variable $oversampling_setting$ (0, 1, 2, 3) in the C code.

Calculation of true temperature and pressure in steps of 1Pa (= 0.01hPa = 0.01mbar) and temperature in steps of 0.1°C.

The following figure shows the detailed algorithm for pressure and temperature measurement.

This algorithm is available to customers as reference C source code ("BMP180_ API") from Bosch Sensortec and via its sales and distribution partners. Please contact your Bosch Sensortec representative for details.



Page 15

Calculation of pressure and temperature for BMP180

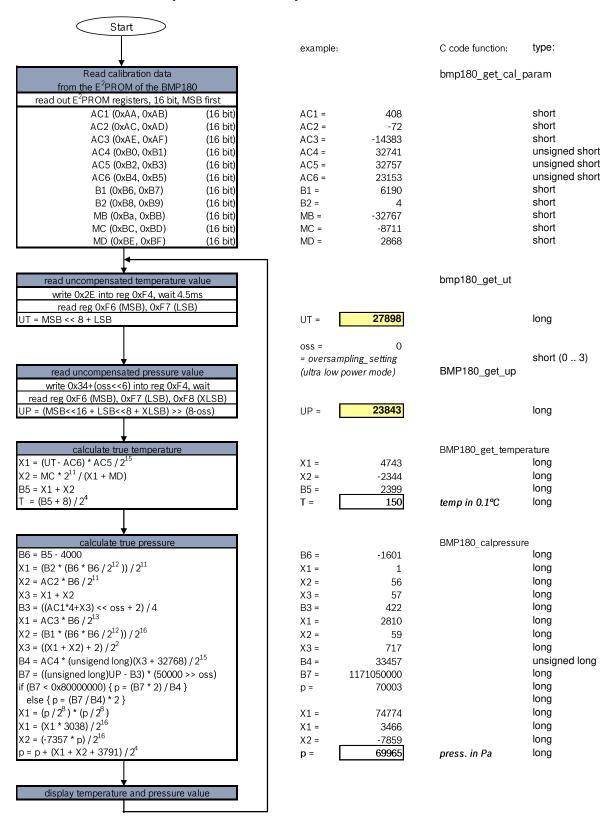


Figure 4: Algorithm for pressure and temperature measurement

3.6 Calculating absolute altitude



With the measured pressure p and the pressure at sea level p_0 e.g. 1013.25hPa, the altitude in meters can be calculated with the international barometric formula:

altitude = 44330 *
$$\left(1 - \left(\frac{p}{p_0}\right)^{\frac{1}{5.255}}\right)$$

Thus, a pressure change of Δp = 1hPa corresponds to 8.43m at sea level.

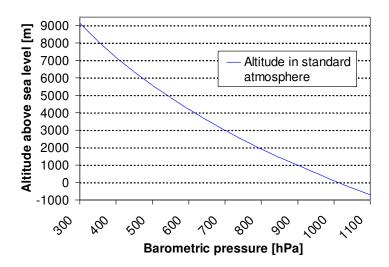


Figure 5: Transfer function: Altitude over sea level – Barometric pressure



Page 17

3.7 Calculating pressure at sea level

With the measured pressure *p* and the absolute altitude the pressure at sea level can be calculated:

$$p_0 = \frac{p}{\left(1 - \frac{altitude}{44330}\right)^{5.255}}$$

Thus, a difference in altitude of Δ altitude = 10m corresponds to 1.2hPa pressure change at sea level.



Page 18

4. Global Memory Map

The memory map below shows all externally accessible data registers which are needed to operate BMP180. The left columns show the memory addresses. The columns in the middle depict the content of each register bit. The colors of the bits indicate whether they are read-only, write-only or read- and writable. The memory is volatile so that the writable content has to be re-written after each power-on.

Not all register addresses are shown. These registers are reserved for further Bosch factory testing and trimming.

Register Name	Register Adress	bit7	bit6	bit5	bit4	bit3	bit2	bit1	bit0	Reset state
out_xlsb	F8h		adc_out_xlsb<7:3> 0 0 0						00h	
out_lsb	F7h		adc out lsb<7:0>						00h	
out_msb	F6h		adc_out_msb<7:0>						80h	
ctrl_meas	F4h	OSS<	oss<1:0> sco measurement control					00h		
soft reset	E0h		reset						00h	
id	D0h		id<7:0>					55h		
calib21 downto calib0	BFh down to AAh			calib	21<7:0> dow	nto calib0<7	:0>			n/a

Registers:	Registers: Control		Data	
	registers	registers	registers	Fixed
Type:	read / write	read only	read only	read only

Figure 6: Memory map

Measurement control (register F4h <4:0>): Controls measurements. Refer to Figure 6 for usage details.

Sco (register F4h <5>): Start of conversion. The value of this bit stays "1" during conversion and is reset to "0" after conversion is complete (data registers are filled).

Oss (register F4h <7:6>): controls the oversampling ratio of the pressure measurement (00b: single, 01b: 2 times, 10b: 4 times, 11b: 8 times).

Soft reset (register E0h): Write only register. If set to 0xB6, will perform the same sequence as power on reset.

Chip-id (register D0h): This value is fixed to 0x55 and can be used to check whether communication is functioning.

After conversion, data registers can be read out in any sequence (i.e. MSB first or LSB first). Using a burst read is not mandatory.



5. I²C Interface

- I²C is a digital two wire interface
- Clock frequencies up to 3.4Mbit/sec. (I2C standard, fast and high-speed mode supported)
- SCL and SDA needs a pull-up resistor, typ. 4.7kOhm to V_{DDIO} (one resistor each for all the I^2C bus)

The I²C bus is used to control the sensor, to read calibration data from the E²PROM and to read the measurement data when A/D conversion is finished. SDA (serial data) and SCL (serial clock) have open-drain outputs.

For detailed I²C-bus specification please refer to: http://www.nxp.com/acrobat_download/literature/9398/39340011.pdf

5.1 I²C specification

Table 6: Electrical parameters for the I²C interface

Parameter	Symbol	Min.	Тур	Max.	Units
Clock input frequency	f_{SCL}			3.4	MHz
Input-low level	V_{IL}	0		0.2 * V _{DDIO}	V
Input-high level	V_{IH}	0.8 * V _{DDIO}		V_{DDIO}	V
Voltage output low level @ $V_{DDIO} = 1.62V$, $I_{OL} = 3mA$	V_{OL}			0.3	V
SDA and SCL pull-up resistor	$R_{\text{pull-up}}$	2.2		10	kOhm
SDA sink current @ $V_{DDIO} = 1.62V$, $V_{OL} = 0.3V$	I _{SDA_sink}		9		mA
Start-up time after power-up, before first communication	t _{Start}	10			Ms



5.2 Device and register address

The BMP180 module address is shown below. The LSB of the device address distinguishes between read (1) and write (0) operation, corresponding to address 0xEF (read) and 0xEE (write).

Table 7: BMP180 addresses

A7	A6	A5	Α4	A3	A2	A1	W/R
1	1	1	0	1	1	1	0/1

5.3 I²C protocol

The I²C interface protocol has special bus signal conditions. Start (S), stop (P) and binary data conditions are shown below. At start condition, SCL is high and SDA has a falling edge. Then the slave address is sent. After the 7 address bits, the direction control bit R/W selects the read or write operation. When a slave device recognizes that it is being addressed, it should acknowledge by pulling SDA low in the ninth SCL (ACK) cycle.

At stop condition, SCL is also high, but SDA has a rising edge. Data must be held stable at SDA when SCL is high. Data can change value at SDA only when SCL is low.

Even though V_{DDIO} can be powered on before V_{DD} , there is a chance of excessive power consumption (a few mA) if this sequence is used, and the state of the output pins is undefined so that the bus can be locked. Therefore, V_{DD} must be powered before V_{DDIO} unless the limitations above are understood and not critical.

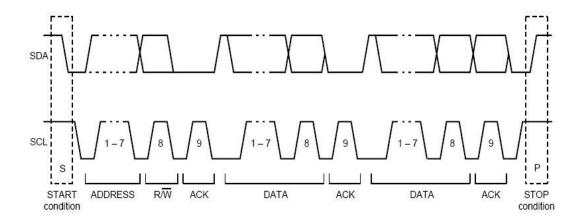


Figure 7: I²C protocol



heet Page 21



5.4 Start temperature and pressure measurement

The timing diagrams to start the measurement of the temperature value UT and pressure value UP are shown below. After start condition the master sends the device address write, the register address and the control register data. The BMP180 sends an acknowledgement (ACKS) every 8 data bits when data is received. The master sends a stop condition after the last ACKS.

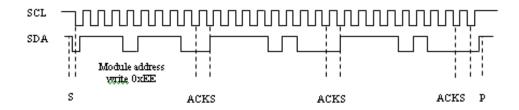


Figure 8: Timing diagram for starting pressure measurement

Abbreviations:

S Start P Stop

ACKS Acknowledge by Slave
ACKM Acknowledge by Master
NACKM Not Acknowledge by Master

Table 8: Control registers values for different internal oversampling setting (oss)

Measurement	Control register value (register address 0xF4)	Max. conversion time [ms]
Temperature	0x2E	4.5
Pressure (oss = 0)	0x34	4.5
Pressure (oss = 1)	0x74	7.5
Pressure (oss = 2)	0xB4	13.5
Pressure (oss = 3)	0xF4	25.5





5.5 Read A/D conversion result or E2PROM data

To read out the temperature data word UT (16 bit), the pressure data word UP (16 to 19 bit) and the E²PROM data proceed as follows:

After the start condition the master sends the module address write command and register address. The register address selects the read register:

E²PROM data registers 0xAA to 0xBF Temperature or pressure value UT or UP 0xF6 (MSB), 0xF7 (LSB), optionally 0xF8 (XLSB)

Then the master sends a restart condition followed by the module address read that will be acknowledged by the BMP180 (ACKS). The BMP180 sends first the 8 MSB, acknowledged by the master (ACKM), then the 8 LSB. The master sends a "not acknowledge" (NACKM) and finally a stop condition.

Optionally for ultra high resolution, the XLSB register with address 0xF8 can be read to extend the 16 bit word to up to 19 bits; refer to the application programming interface (API) software rev. 1.1 ("BMP180_ API", available from Bosch Sensortec).

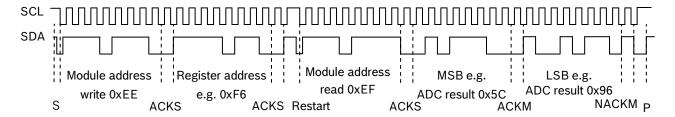


Figure 9: Timing diagram read 16 bit A/D conversion result



6. Package

6.1 Pin configuration

Picture shows the device in top view. Device pins are shown here transparently only for orientation purposes.

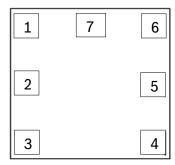


Figure 10: Layout pin configuration BMP180

Table 9: Pin configuration BMP180

in No	Name	Function
1	CSB*	Chip select
2	VDD	Power supply
3	VDDIO	Digital power supply
4	SDO*	SPI output
5	SCL	I2C serial bus clock input
6	SDA	I2C serial bus data (or SPI input)
7	GND	Ground

^{*} A pin compatible product variant with SPI interface is possible upon customer's request. For I²C (standard case) CSB and SDO are not used, they have to be left open. All pins have to be soldered to the PCB for symmetrical stress input even though they are not connected internally.



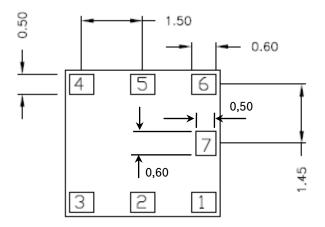


6.2 Outline dimensions

The sensor housing is a 7Pin LGA package with metal lid. Its dimensions are 3.60mm (± 0.1 mm) x 3.80mm (± 0.1 mm) x 0.93mm (± 0.07 mm).

Note: All dimensions are in mm.

6.2.1 Bottom view



BOTTOM VIEW

Figure 11: Bottom view BMP180



6.2.2 Top view

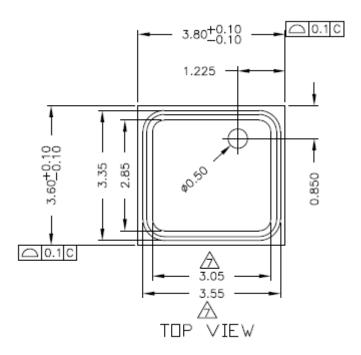


Figure 12: Top view BMP180

6.2.3 Side view

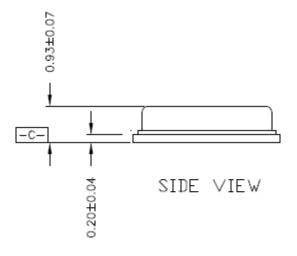


Figure 13: Side view BMP180